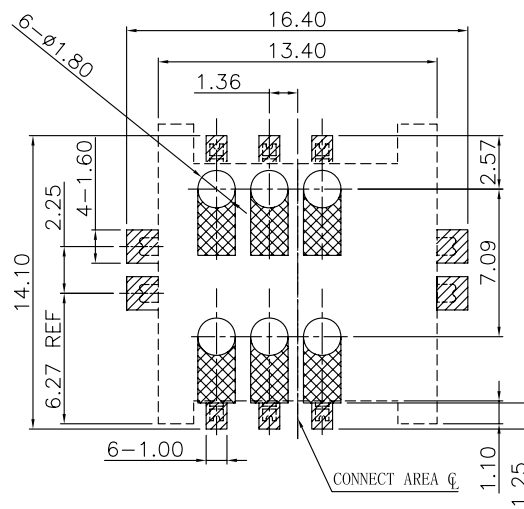
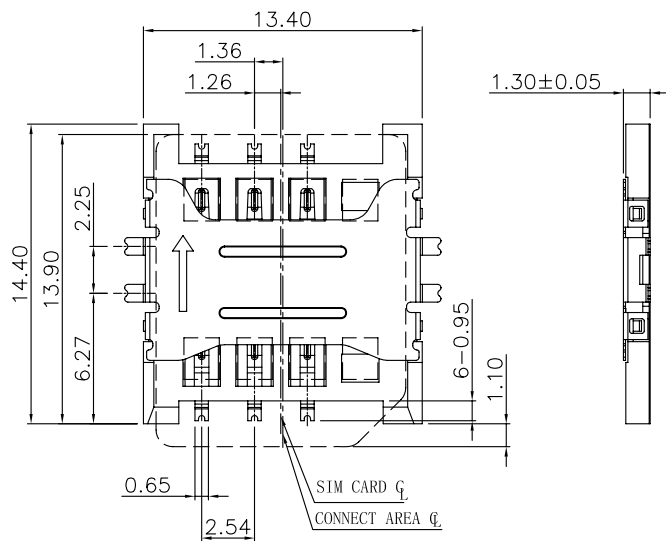
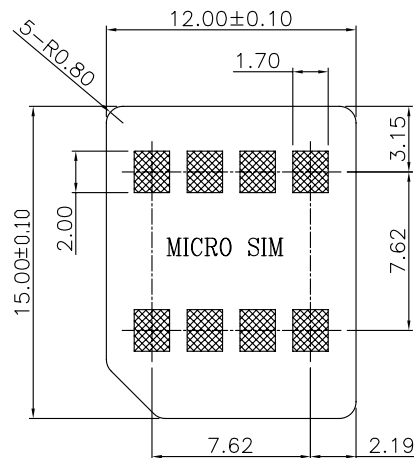
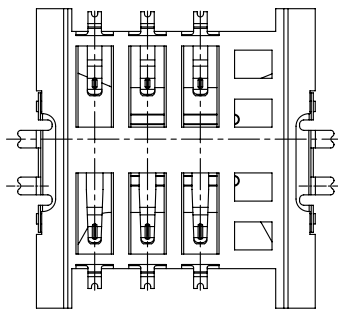
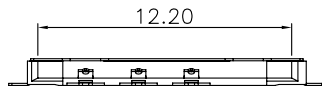
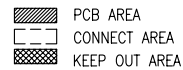


REV.	DESCRIPTION	DATE
A	RELEASE	SEP. 16, 2013
B	SPEC. MODIFY	OCT. 07, 2014



RECOMMEND PCB LAYOUT  
TOLERANCE:  $\pm 0.05$   
TOP VIEW



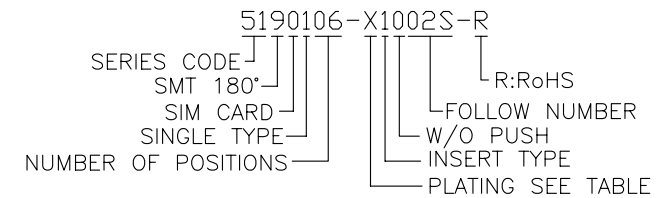
### MATERIALS

- HOUSING : THERMOPLASTIC (UL 94V-0).
- TERMINAL : COPPER ALLOY, PLATING SEE TABLE.
- SHELL : SUS  
PLATING : NICKEL PLATED OVERALL.  
GOLD PLATED ON SOLDER TAILS.

### SPECIFICATION

- CURRENT RATING : 0.5 A. MAX.
- DIELECTRIC WITHSTANDING VOLTAGE :  
500V AC R.M.S. FOR 1 MINUTE.
- INSULATION RESISTANCE : 1000MΩ MIN. AT 500V DC.
- CONTACT RESISTANCE : 30mΩ MAX.
- OPERATING TEMPERATURE :  $-40^{\circ}\text{C}$  TO  $+85^{\circ}\text{C}$ .

### PART NUMBER INFORMATION :



DESCRIPTION OF PLATING ON TERMINALS			
NO.	EXPLAIN	NO.	EXPLAIN
0	GOLD FLASH	3	GOLD 15u"
1	GOLD 5u"	4	GOLD 20u"
2	GOLD 10u"	6	G/F + TIN

TOLERANCE .0=±0.25 .00=±0.15 .000=±0.05 ANG.=±3°	DRAWER <i>JIN</i> CHECK <i>JANPE</i> APP'D <i>ERP</i>	 ASTRON TECHNOLOGY CORP. NAME MICRO SIM SOCKET 6PIN 1.30H DRAW NO. R5190106-X1002S-R
 UNITS : mm SCALE NONE   SIZE A7   SHEET 1 OF 1   REV. B	PRODUCT SPEC. ---	